

# N-Channel Super Junction Power MOSFET II

## General Description

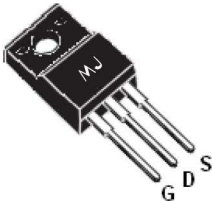
The series of devices use advanced super junction technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

## Features

- ◆ New technology for high voltage device
- ◆ Low on-resistance and low conduction losses
- ◆ Small package
- ◆ Ultra Low Gate Charge cause lower driving requirements
- ◆ 100% Avalanche Tested
- ◆ ROHS compliant



Schematic diagram



TO-220F

## Application

- ◆ Power factor correction (PFC)
- ◆ Switched mode power supplies(SMPS)
- ◆ Uninterruptible Power Supply (UPS)

$V_{DS}$	650	V
$R_{DS(ON)}$	900	mΩ
$I_D$	5	A

## Package Marking And Ordering Information

Device	Device Package	Marking
MJ65R900F	TO-220F	MJ65R900F

Table 1. Absolute Maximum Ratings ( $T_c=25^{\circ}C$ )

Parameter	Symbol	MJ65R900F	Unit
Drain-Source Voltage ( $V_{GS}=0V$ )	$V_{DS}$	650	V
Gate-Source Voltage ( $V_{DS}=0V$ )	$V_{GS}$	$\pm 30$	V
Continuous Drain Current at $T_c=25^{\circ}C$	$I_D$ (DC)	5*	A
Continuous Drain Current at $T_c=100^{\circ}C$	$I_D$ (DC)	3*	A
Pulsed drain current <sup>(Note 1)</sup>	$I_{DM}$ (pluse)	15*	A
Drain Source voltage slope, $V_{DS} = 480\text{ V}$ , $I_D = 5\text{ A}$ , $T_j = 125\text{ }^{\circ}C$	$dv/dt$	48	V/ns
Maximum Power Dissipation ( $T_c=25^{\circ}C$ )	$P_D$	29	W
Derate above $25^{\circ}C$	$P_D$	0.23	W/ $^{\circ}C$
Single pulse avalanche energy <sup>(Note 2)</sup>	$E_{AS}$	135	mJ
Avalanche current <sup>(Note 1)</sup>	$I_{AR}$	2.5	A

Parameter	Symbol	Value	Unit
Repetitive Avalanche energy , $t_{AR}$ limited by $T_{jmax}$ <sup>(Note 1)</sup>	$E_{AR}$	0.4	mJ
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55...+150	$^{\circ}C$

\* limited by maximum junction temperature

Table 2. Thermal Characteristic

Parameter	Symbol	MJ65R900F	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R <sub>thJC</sub>	4.3	°C/W
Thermal Resistance, Junction-to-Ambient (Maximum)	R <sub>thJA</sub>	80	°C/W

Table 3. Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
On/off states						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	650	-	-	V
Zero Gate Voltage Drain Current (Tc=25°C)	I <sub>DSS</sub>	V <sub>DS</sub> =650V,V <sub>GS</sub> =0V	-	-	1	μA
Zero Gate Voltage Drain Current (Tc=125°C)	I <sub>DSS</sub>	V <sub>DS</sub> =650V,V <sub>GS</sub> =0V	-	-	50	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±30V,V <sub>DS</sub> =0V	-	-	±100	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250μA	2.5	3	3.5	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V,I <sub>D</sub> =3A	-	780	900	mΩ
Dynamic Characteristics						
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> =20V,I <sub>D</sub> =3A	-	4.8	-	S
Input Capacitance	C <sub>ies</sub>	V <sub>DS</sub> =50V,V <sub>GS</sub> =0V F=1.0MHz	-	460	-	PF
Output Capacitance	C <sub>oss</sub>		-	45	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	3.5	-	PF
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =480V,I <sub>D</sub> =5A V <sub>GS</sub> =10V	-	10	20	nC
Gate-Source Charge	Q <sub>gs</sub>		-	1.6	-	nC
Gate-Drain Charge	Q <sub>gd</sub>		-	4	-	nC
Intrinsic gate resistance	R <sub>G</sub>	f=1 MHz open drain	-	2.5	-	Ω
Switching times						
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> =380V,I <sub>D</sub> =5A R <sub>G</sub> =18Ω,V <sub>GS</sub> =10V	-	6	-	nS
Turn-on Rise Time	t <sub>r</sub>		-	3	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>		-	50	60	nS
Turn-Off Fall Time	t <sub>f</sub>		-	9	15	nS
Source- Drain Diode Characteristics						
Source-drain current (Body Diode)	I <sub>SD</sub>	T <sub>C</sub> =25°C	-	-	5	A
Pulsed Source-drain current (Body Diode)	I <sub>SDM</sub>		-	-	15	A
Forward On Voltage	V <sub>SD</sub>	T <sub>J</sub> =25°C,I <sub>SD</sub> =5A,V <sub>GS</sub> =0V	-	1	1.3	V
Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> =25°C,I <sub>F</sub> =5A di/dt=100A/μs	-	250	-	nS
Reverse Recovery Charge	Q <sub>rr</sub>		-	2.2	-	uC
Peak reverse recovery current	I <sub>rrm</sub>		-	15	-	A

## Notes

- 1.Repetitive Rating: Pulse width limited by maximum junction temperature
- 2.T<sub>J</sub>=25℃,V<sub>DD</sub>=50V,V<sub>G</sub>=10V, R<sub>G</sub>=25Ω

## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

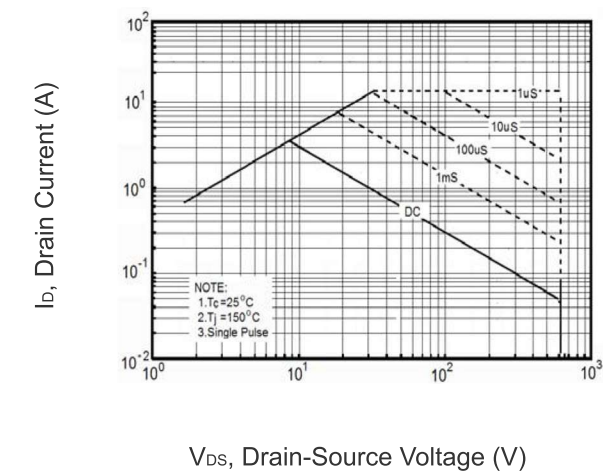


Figure 1 Safe operating area

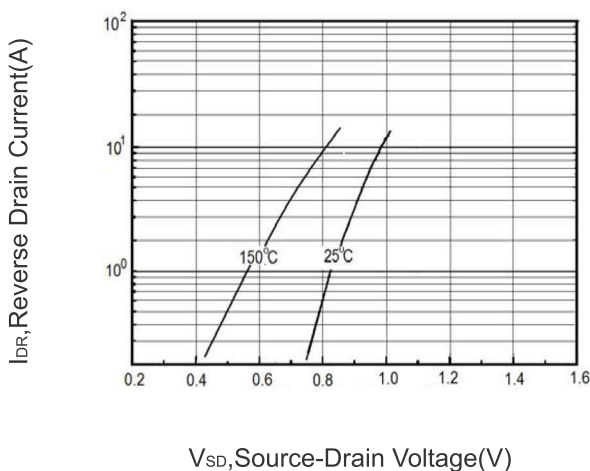


Figure 2 Source-Drain Diode Forward Voltage

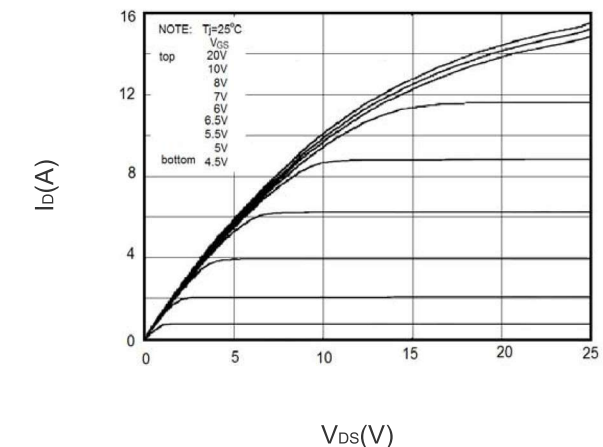


Figure 3 Output characteristics

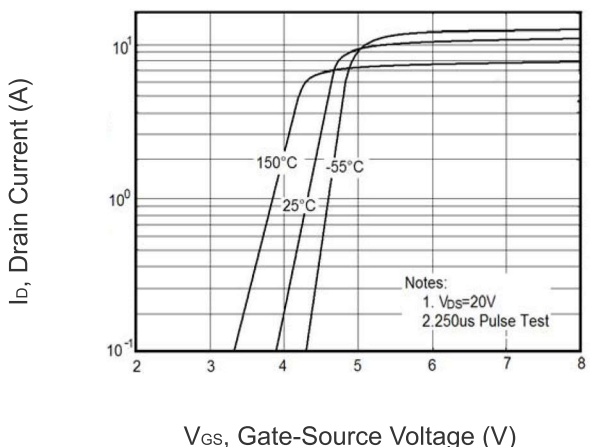


Figure 4 Transfer characteristics

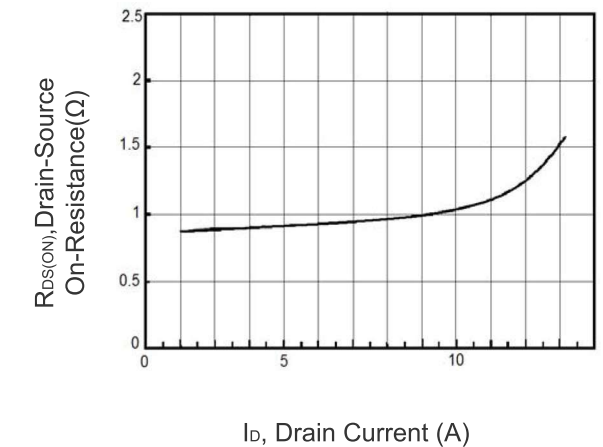


Figure 5 Static drain-source on resistance

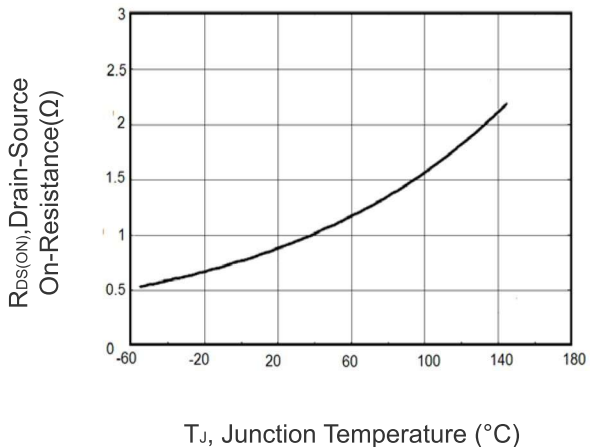


Figure 6  $R_{DS(ON)}$  vs Junction Temperature

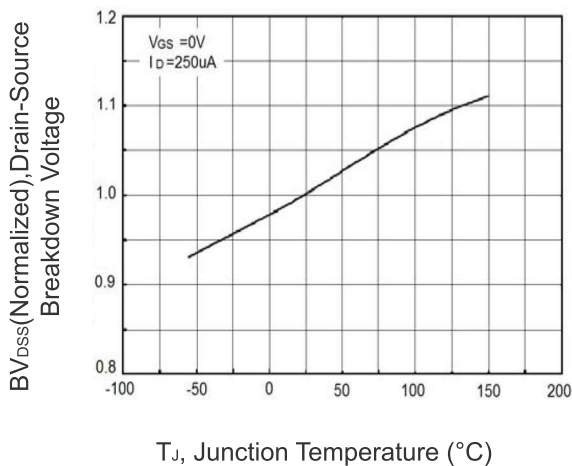


Figure 7  $BV_{DSS}$  vs Junction Temperature

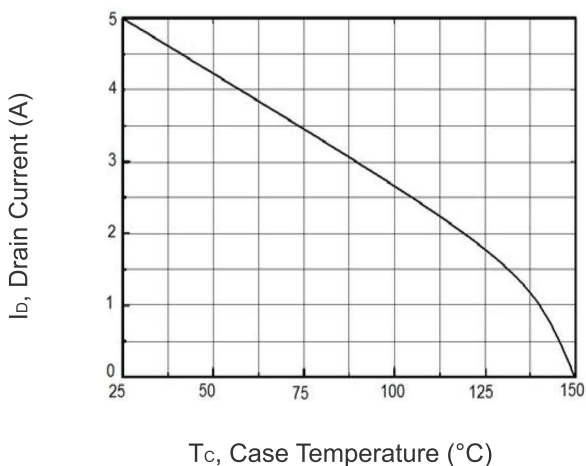


Figure 8 Maximum  $I_D$  vs Junction Temperature

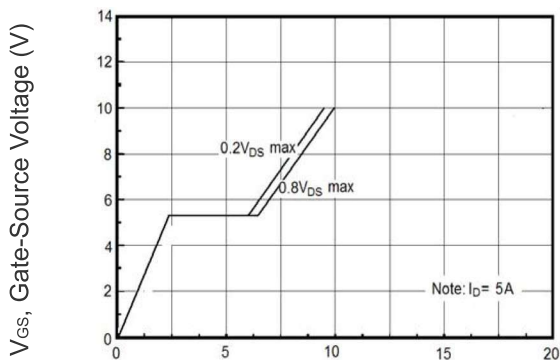


Figure 9 Gate charge waveforms

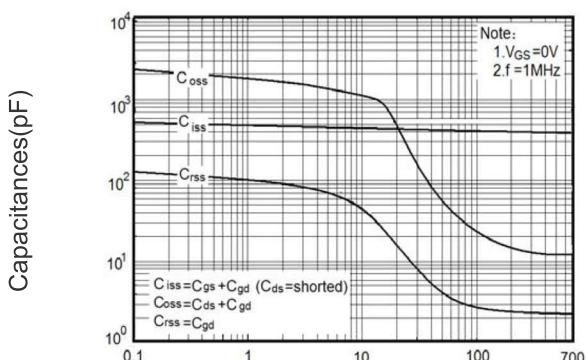


Figure 10 Capacitance

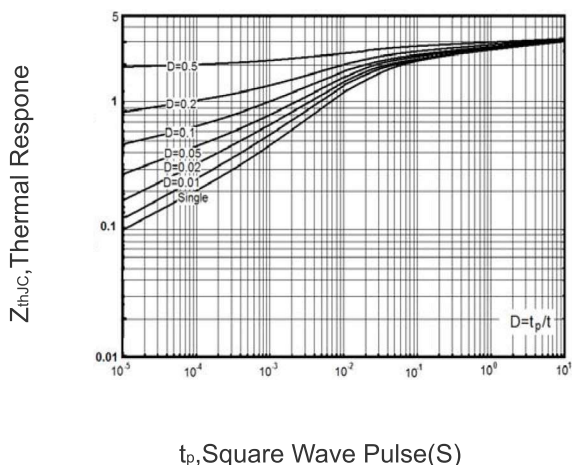
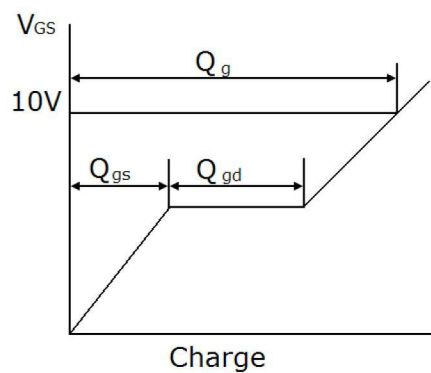
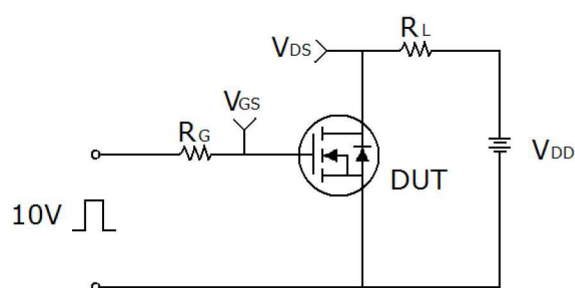


Figure 11 Transient Thermal Impedance

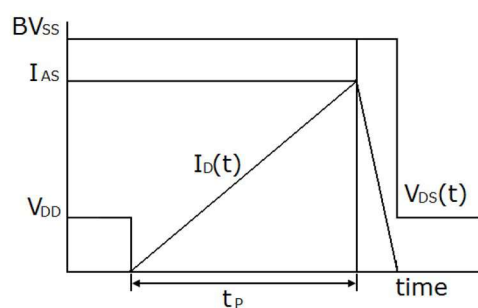
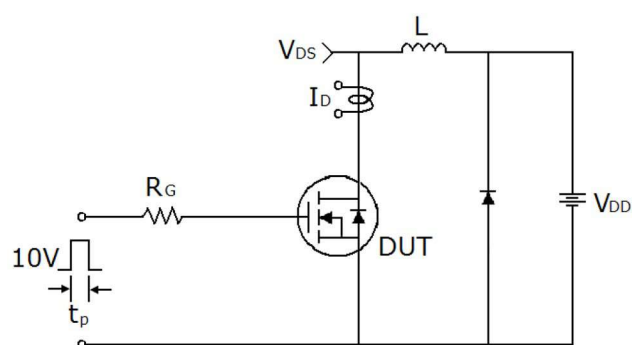
## Test circuit



Gate charge test circuit & Waveform

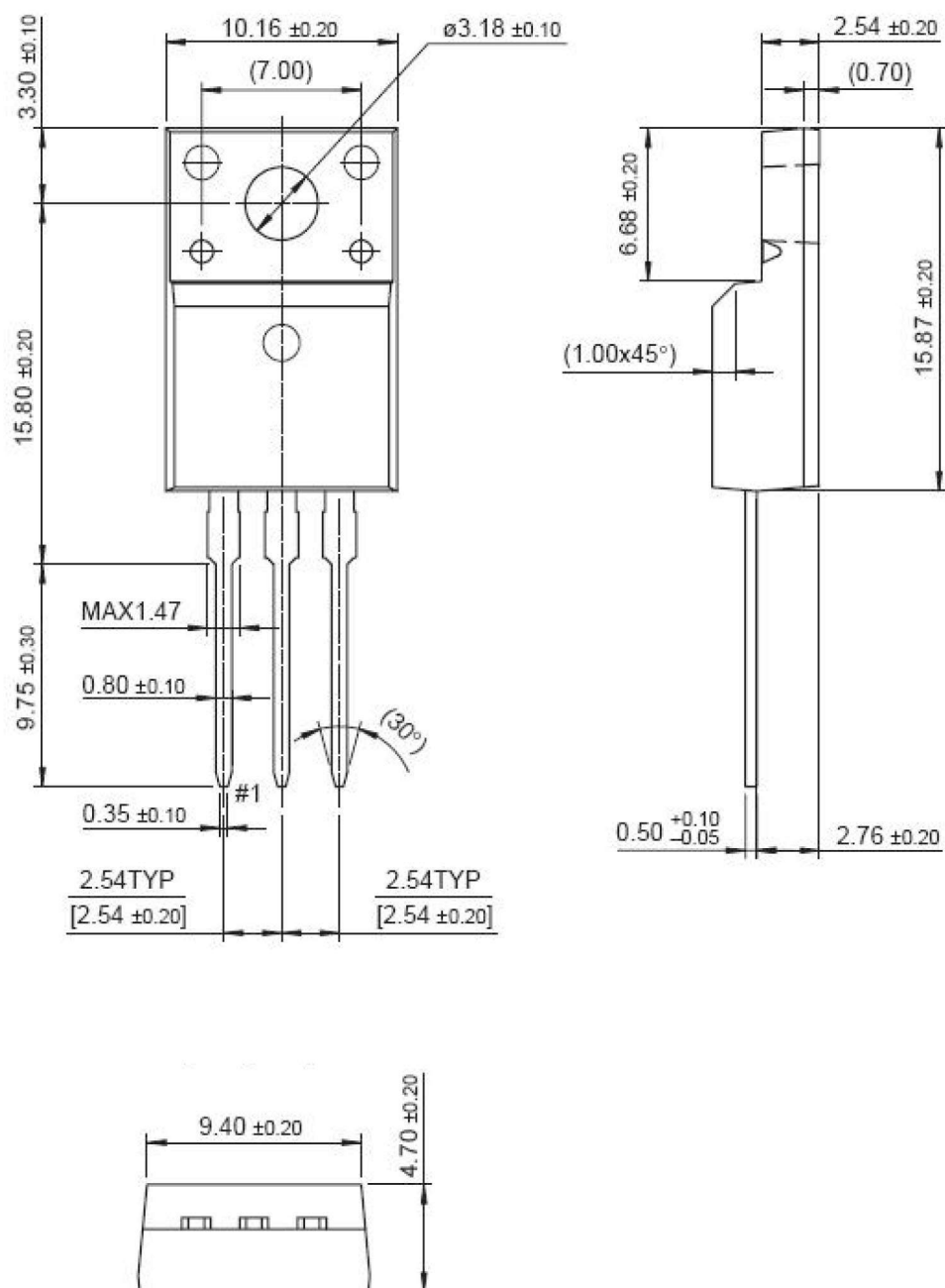


Switch Time Test Circuit



Unclamped Inductive Switching Test Circuit & Waveforms

# TO-220F Package Information



Dimensions in Millimeters

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